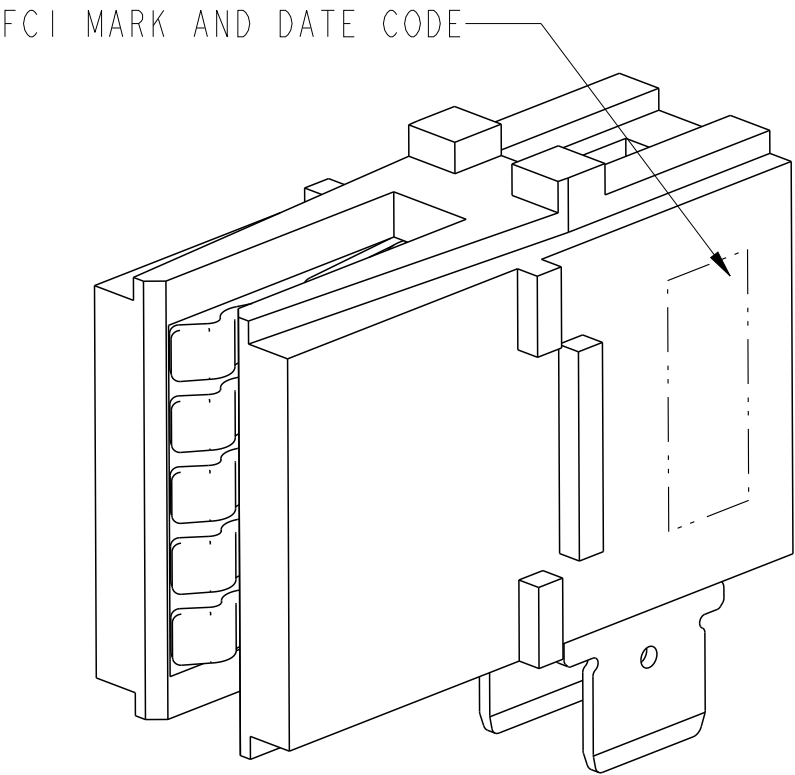
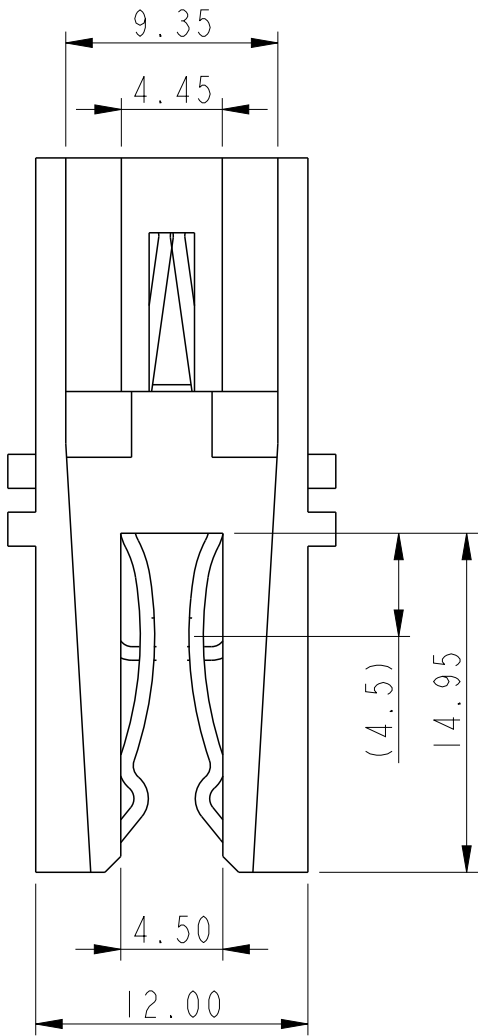
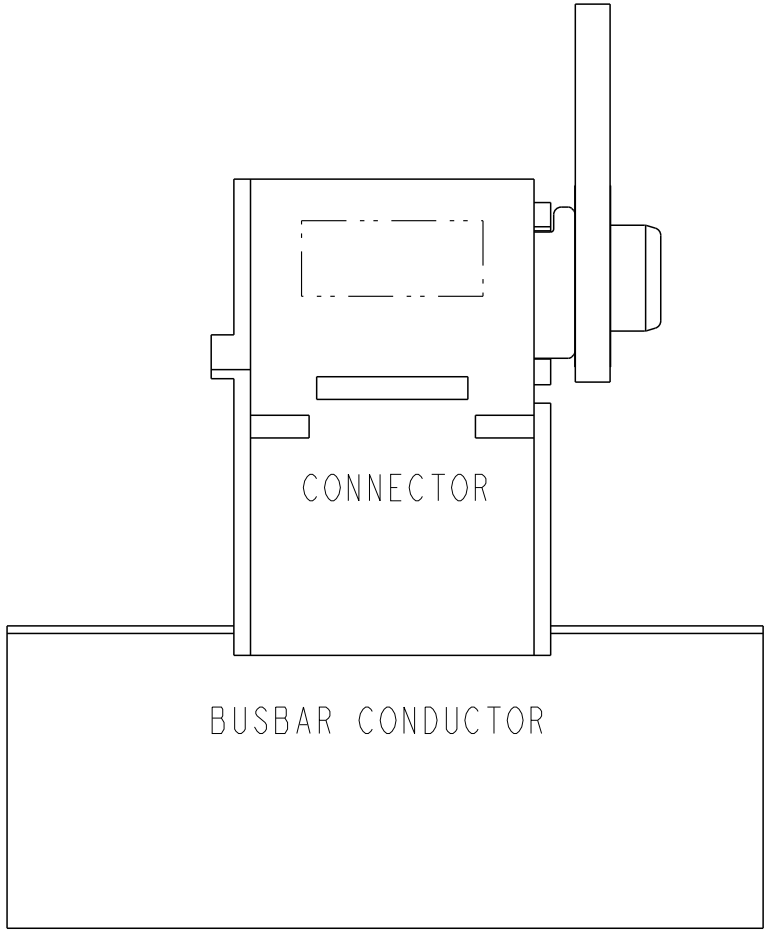
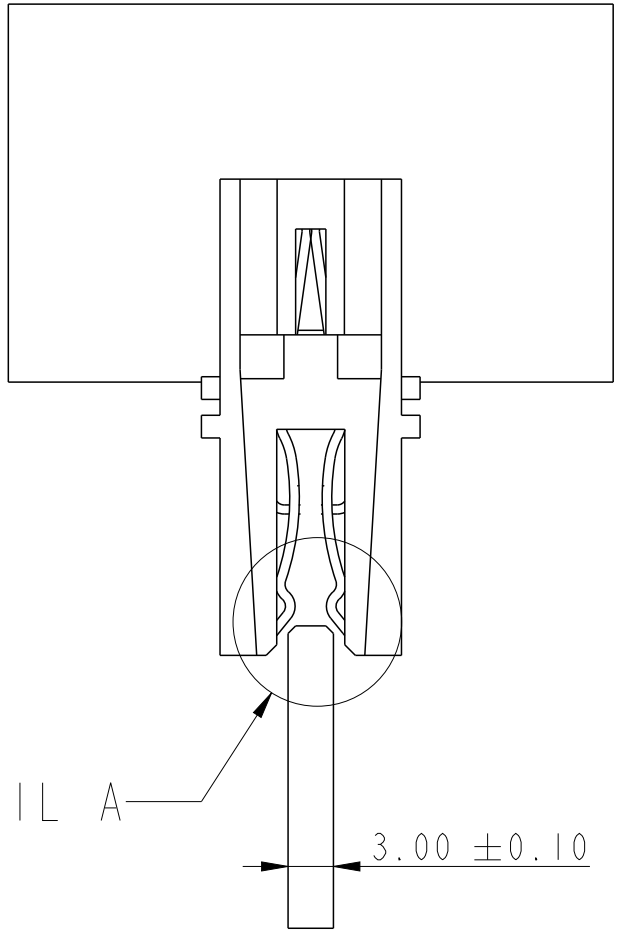
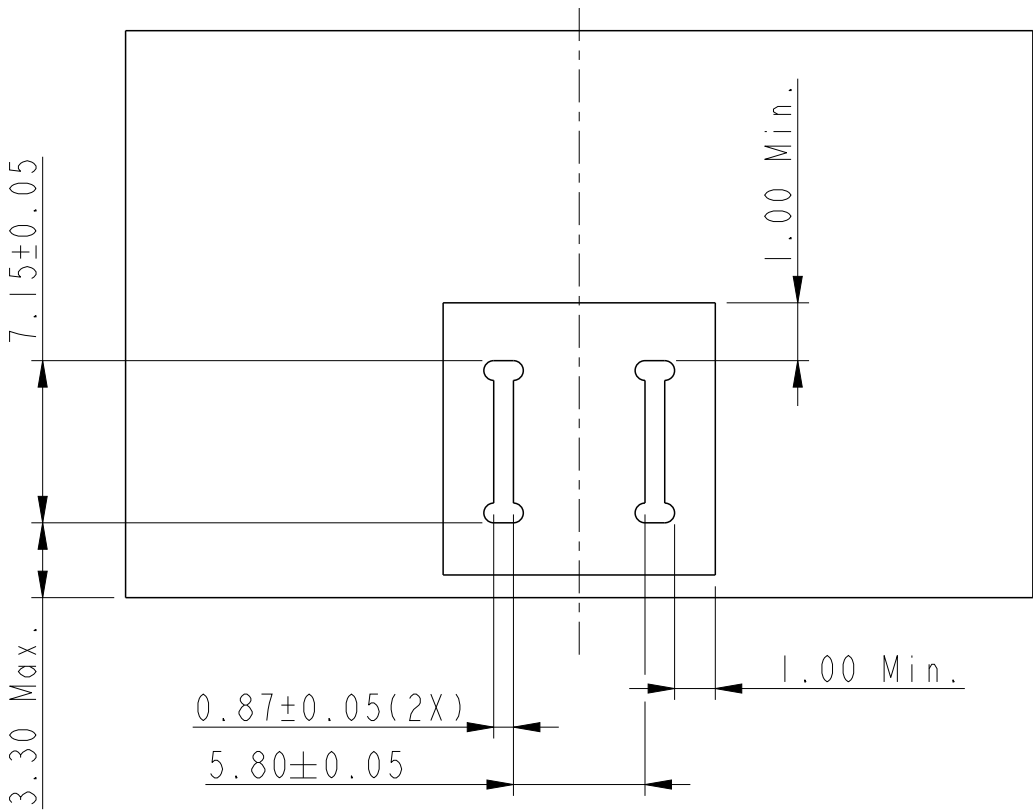
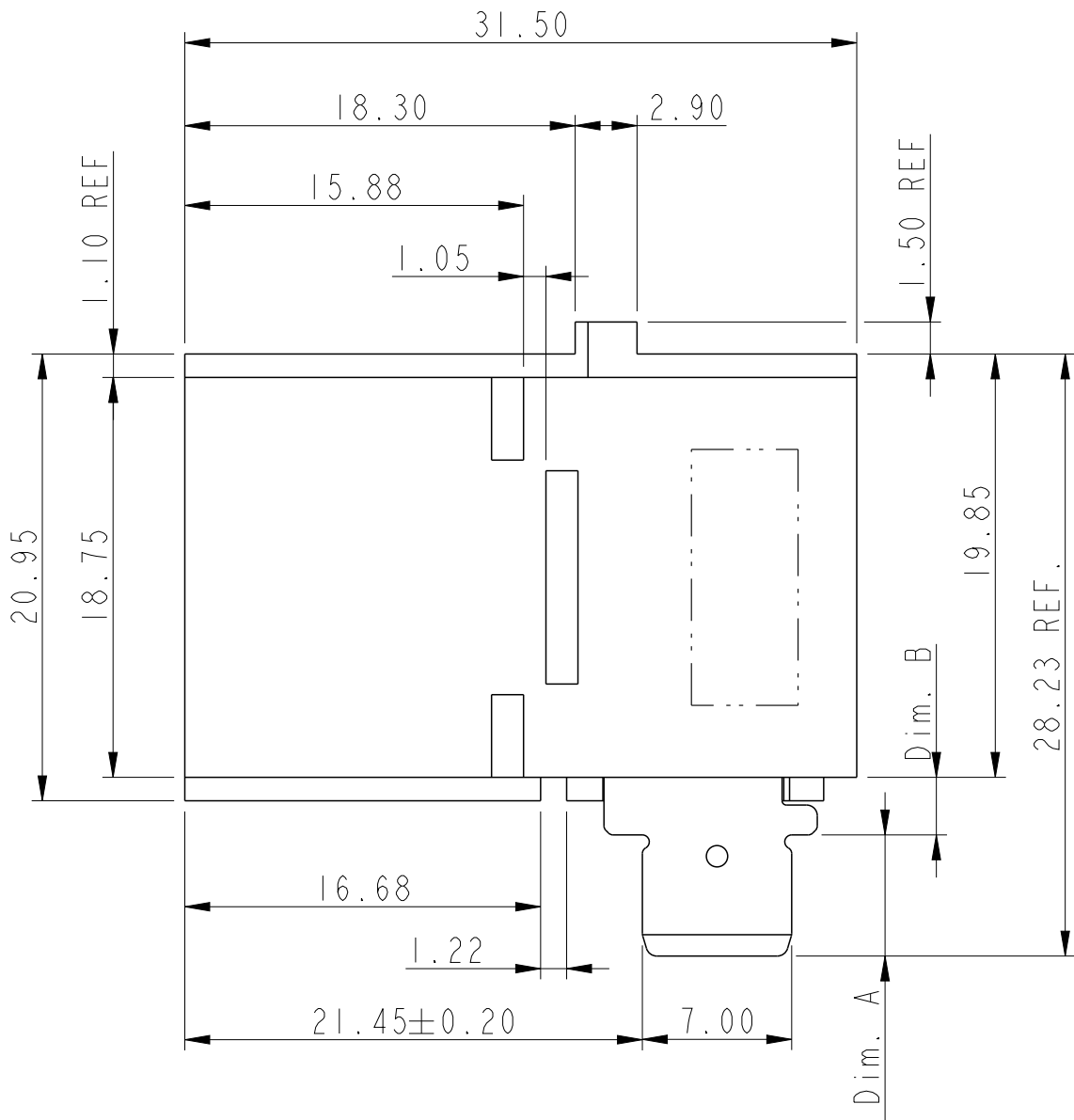
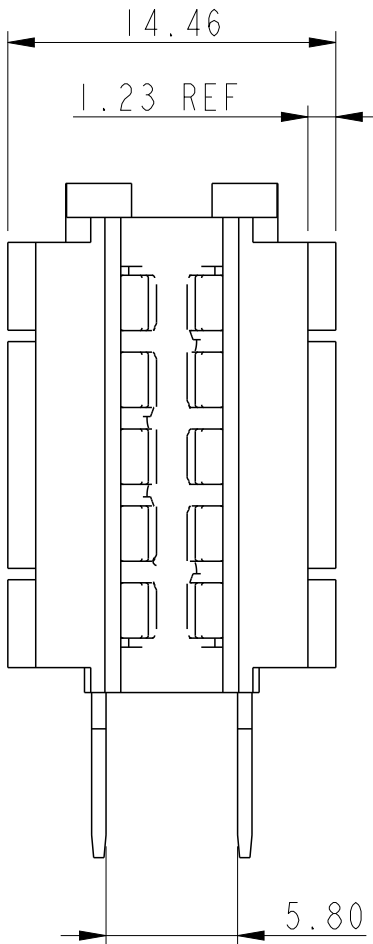
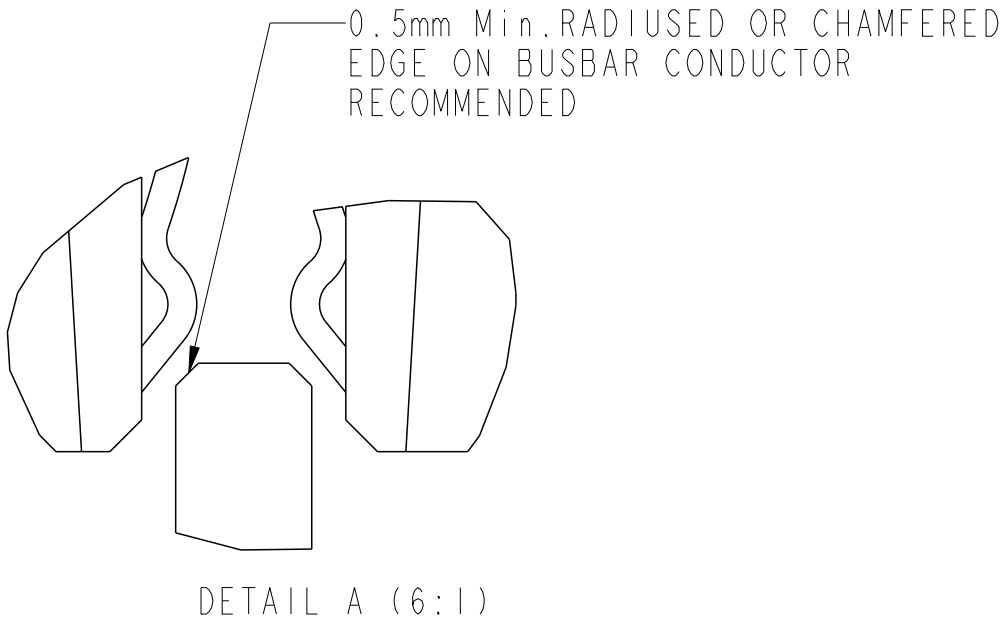


1	2	3	4	5	6	7	8
PRODUCT NUMBER	DESCRIPTION(PLATING)		Dim. A	Dim. B	PCB THICKNESS		
10125600-S01LF	CONTACT AREA:AGT PLATING-3.0um SILVER OVER 1.27um NICKEL 		5.68	2.70	4.80 Max.		
10125600-S02LF	CONTACT AREA:AGT PLATING-3.0um SILVER OVER 1.27um NICKEL 		4.40	4.00	2.00 Max.		

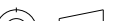
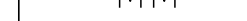


PCB AND BUSBAR-CONDUCTOR
IN THESE VIEWS ARE SHOWN FOR REFERENCE ONLY.



- NOTES:
- 1.CONNECTOR HOUSING:
HIGH TEMPERATURE THERMOPLASTIC GLASS FILLED, UL 94V-0
TERMINALS: COPPER ALLOY
 - 2.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK
TEMPERATURE FOR 10 SECOND IN A WAVE SOLDER
APPLANTION WITH CIRCUIT BOARD.
 - 3.FINISHES:
SEE PRODUCT NUMBER
 - 4.PRODUCT SPECIFICATION: GS-12-1179
APPLICATION SPECIFICATION: GS-20-0396
PACKING SPECIFICATION: GS-14-2376
 - 5.THE CONNECTOR MUST BE SUPPORTED WITH A FIXTURE
DURING WAVE SOLDERING PROCESS

RECOMMENDED PCB LAYOUT
THICKNESS 4.8mm Max.

spec ref -		dr Zhao Peter		2013/06/20		projection		MM		size A2		scale 3:1	
tolerance std		eng Jacklin Zou		2017/06/22						ecn no		ELX-DG-27194-1	
ISO 406 ISO 1101		TOLERANCES UNLESS OTHERWISE SPECIFIED		chr -						rel level		Released	
		appr Pei-Ming Zheng		2017/06/28		product family							
surface -		linear		0.X ±0.30		Amphenol FCI		title Solder Tab		dwg no 10125600		rev D	
		0.XX ±0.25		Barklip R/A CONNECTOR									
		0.XXX ±0.10											
ISO 1302		angular 0° ±2°		www.fci.com		cat. no. -		Product - Customer Drw		sheet 1 of 1			